



SAP Blended Learning Academy – Course Dates 2021

WS4HPP – Manufacturing in SAP S/4HANA (PP)

PUBLIC



SAP Blended Learning Academy

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Schedule	Kick Off	Review 1	Review 2	Review 3	Review 4	Region	Timezone	Language
1	08.03.21	14.04.21	19.05.21	23.06.21	26.07.21	DACH	CET, Berlin	German*
2	19.04.21	26.05.21	30.06.21	04.08.21	08.09.21	Americas	EST, Boston	English
3	03.05.21	09.06.21	07.07.21	11.08.21	15.09.21	EMEEA	CET, Brüssels	English
4	21.06.21	28.07.21	01.09.21	29.09.21	08.11.21	DACH	CET, Berlin	German*
5	05.07.21	02.08.21	06.09.21	13.10.21	15.11.21	APJ	IST, India	English
6	27.09.21	10.11.21	15.12.21	17.01.22	21.02.22	DACH	CET, Berlin	German*
7	04.10.21	03.11.21	06.12.21	12.01.22	16.02.22	Americas	EST, Boston	English
8	18.10.21	17.11.21	20.12.21	26.01.22	02.03.22	EMEEA	CET, Brüssels	English
9	29.11.21	10.01.22	14.02.22	14.03.22	11.04.22	APJ	IST, India	English
10	13.12.21	19.01.22	23.02.22	30.03.22	04.05.22	DACH	CET, Berlin	German*

*Live sessions in German language/Training material partly in English

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